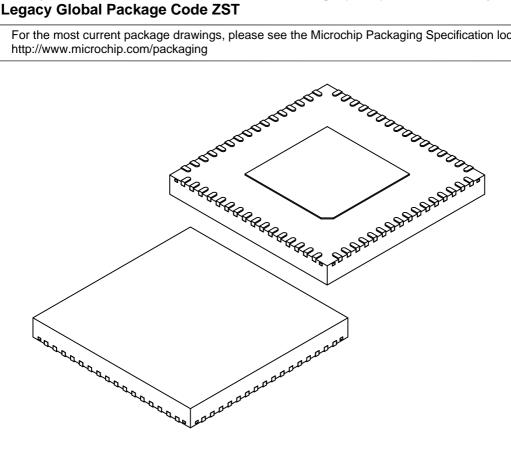
## 64-Lead Very Thin Plastic Quad Flat, No Lead Package (TMB) - 9x9 mm Body [VQFN] **Atmel Legacy Global Package Code ZST**

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Terminals	N	64		
Pitch	е	0.50 BSC		
Overall Height	Α	0.80	0.90	1.00
Standoff	A1	0.00	0.02	0.05
Terminal Thickness	A3	0.203 REF		
Overall Length	D	9.00 BSC		
Exposed Pad Length	D2	4.60	4.70	4.80
Overall Width	E	9.00 BSC		
Exposed Pad Width	E2	4.60	4.70	4.80
Terminal Width	b	0.15	0.20	0.25
Terminal Length	L	0.30	0.40	0.55
Terminal-to-Exposed-Pad	K	0.20	-	-

## Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Package is saw singulated
- 3. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.